

AS1747

Low-Voltage, Dual SPDT, Audio Clickless Switch with Negative Rail Capability

1 General Description

The SPDT (single-pole/double-throw) switch AS1747 allows signals below ground to pass through without distortion. This analog switch is ideal for switching audio signals, due to the supply voltage from +1.8V to +5.5V and the low 0.4Ω on-resistance.

This SPDT switch is available in space-saving 10-pin TDFN 3x3 packages and operate over the -40°C to +85°C extended temperature range.

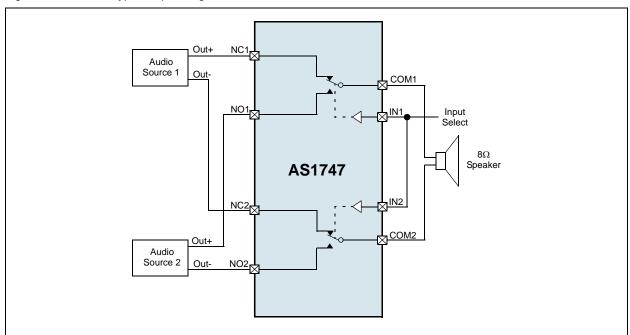
2 Key Features

- Distortion -Free Negative Signal Throughput Down to Vcc - 5.5V
- Low On-Resistance (R_{ON})
 0.4Ω at +2.7V Supply
- 0.25Ω On-Resistance Flatness
- 0.03Ω On-Resistance Matching
- +1.8V to 5.5V Supply Voltage
- -90dB Crosstalk (100kHz)
- -65dB Off-Isolation (100kHz)
- Available in 10-pin TDFN 3x3 Packages

3 Applications

The device is ideal for cell phones, PDAs and hand-held devices, notebook computers and MP3 players.

Figure 1. AS1747 - Typical Operating Circuit

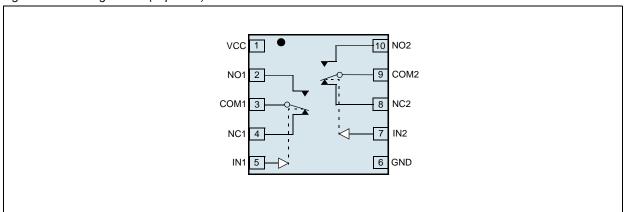




4 Pinout

Pin Assignment

Figure 2. Pin Assignments (Top View)



Pin Description

Table 1. Pin Description

Pin Name	TDFN	Description
VCC	1	Positive-Supply Voltage Input
NO1	2	Analog Switch 1 - Normally Open Terminal
COM1	3	Analog Switch 1 - Common Terminal
NC1	4	Analog Switch 1 - Normally Closed Terminal
IN1	5	Digital Control Input for Analog Switch 1. A logic LOW on IN1 connects COM1 to NC1 and a logic HIGH connects COM1 to NO1.
GND	6	Ground
IN2	7	Digital Control Input for Analog Switch 2. A logic LOW on IN2 connects COM2 to NC2 and a logic HIGH connects COM2 to N02.
NC2	8	Analog Switch 2 - Normally Closed Terminal
COM2	9	Analog Switch 2 - Common Terminal
NO2	10	Analog Switch 2 - Normally Open Terminal



5 Absolute Maximum Ratings

Stresses beyond those listed in Table 2 may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in Electrical Characteristics on page 4 is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Table 2. Absolute Maximum Ratings

Parameter	Min	Max	Units	Comments
Vcc, IN_	-0.3	+6.0	V	
COM_, NO_, NC_	Vcc - 6	Vcc + 0.3	V	
Closed-Switch Continuous Current COM_, NO_, NC_		±150	mA	
Open-Switch Continuous Current NO_, NC_		±30	mA	
Peak Current COM_, NO_, NC_ (pulsed at 1ms, 10% duty cycle)		±400	mA	
Continuous Power Dissipation (T _A = +70°C)				
10-Pin TDFN (derate 24.4mW/°C above +70°C)		1951	mW	
ESD	2	2	kV	HBM MIL-Std. 883E 3015.7 methods
Latchup Immunity	-200	+200	mA	@25°C, <i>JEDEC 7</i> 8
Operating Temperature Range	-40	+85	°C	
Junction Temperature		+150	°C	
Storage Temperature Range	-65	+150	°C	
Package Body Temperature		+260	°C	The reflow peak soldering temperature (body temperature) specified is in accordance with IPC/JEDEC J-STD-020D "Moisture/Reflow Sensitivity Classification for Non-Hermetic Solid State Surface Mount Devices". The lead finish for Pb-free leaded packages is matte tin (100% Sn).



6 Electrical Characteristics

Vcc = +2.7V to +5.5V, T_A = -40°C to +85°C, unless otherwise specified. Typical values are at Vcc = +3.0V, T_A = +25°C, unless otherwise specified.

Table 3. Electrical Characteristics

Symbol	Parameter	Condition		Min	Тур	Max	Unit
Analog Sw	ritch						
V _{NO} _ V _{NC} _ V _{COM} _	Analog Signal Range			Vcc - 5.5		Vcc	V
R _{ON(NC)}		Vcc = 2.7V; V _{NC} _or V _{NO} _ = Vcc - 5.5V, -1V, 0V, 1V, 2V, Vcc; I _{COM} _ = 100mA	$T_A = +25^{\circ}C$		0.4	0.85	
R _{ON(NO)}	On-Resistance		$T_A = T_{MIN}$ to T_{MAX}			0.95	Ω
	On-Resistance Match	$VCC = 2.7V$, V_{NC} or $V_{NO} = 0V$,	$T_A = +25^{\circ}C$		0.03	0.1	Ω
ΔR _{ON}	Between Channels	I _{COM} = 100mA	$T_A = T_{MIN}$ to T_{MAX}			0.15	
5	On-Resistance	$VCC = 2.7V; V_{NC} \text{ or } V_{NC} = -1V,$	$T_A = +25^{\circ}C$		0.25	0.4	
R _{FLAT(NC)}	Flatness	0V, 1V, 2V, Vcc; I _{COM} = 100mA	$T_A = T_{MIN}$ to T_{MAX}			0.45	Ω
I _{NO_(OFF)}	NO_, NC_	Vcc = 2.7V, switch open;	$T_A = +25^{\circ}C$	-10		+10	
I _{NC_(OFF)}	Off-Leakage Current	V_{NC} or V_{NO} = -2.5V, +2.5V; V_{COM} = +2.5V, -2.5V	$T_A = T_{MIN}$ to T_{MAX}	-200		+200	nA
	COM	Vcc = 2.7V, switch closed;	$T_A = +25^{\circ}C$	-10		+10	
I _{COM_(ON)}	On-Leakage Current	V_{NC} or V_{NO} = -2.5V, +2.5V; or floating; V_{COM} = -2.5V, +2.5V, or floating	$T_A = T_{MIN}$ to T_{MAX}	-200		+200	nA
Dynamic C	haracteristics						
	1	$\begin{split} &V_{NO}=2.5\text{V}; \text{for NO}_, \text{VIN}_=0\text{V to}\\ &\text{Vcc; for NC}_, \text{VIN}_=\text{Vcc to 0V};\\ &\text{R}_L=300\Omega, \text{C}_L=35\text{pF, Figure 15} \end{split}$	$T_A = +25^{\circ}C$		200	400	
ton Turn-On Time ¹	Turn-On Time ¹		$T_A = T_{MIN}$ to T_{MAX}			400	ns
	1	V _{NC} = 2.5V; for NO_, V _{IN} _ = V _{CC}	$T_A = +25^{\circ}C$		100	200	
^t OFF	Turn-Off Time ¹	to 0V; for NC_, VIN_ = 0V to Vcc; R _L = 300Ω , C _L = 35 pF, Figure 15	$T_A = T_{MIN}$ to T_{MAX}			200	ns
t _D	Break-Before-Make Time Delay	$V_{N_}$ = 2.5V, for NO_, VIN_ = Vcc to 0V; for NC_, VIN_ = 0V to Vcc; R _L = 300 Ω , C _L = 35pF, Figure 16			200		ns
Q	Charge Injection	$V_{COM} = 0V$, $R_S = 0\Omega$, $C_L = 1.0$ nF, Figure 17			2		рC
V _{ISO}	Off-Isolation	Vcc = 5V, f = 100kHz, V_{COM} = 1 V_{RMS} , R_L = 50 Ω , C_L = 5pF, Figure 18			-65		dB
V _{CT}	Crosstalk	Vcc = 5V, f = 100kHz, V_{COM} = 1 V_{RMS} , R_L = 50Ω , C_L = 5pF, Figure 18			-90		dB
PSRR	Power-Supply Rejection Ratio	$f = 10kHz$, $V_{COM} = 1V_{RMS}$, $R_L = 50\Omega$, $C_L = 5pF$			70		dB
BW	On-Channel-3dB Bandwidth	Vcc = 5V, Signal = 0dBm, R_L = 50 Ω , C_L = 5pF, Figure 18			31		MHz
THD	Total Harmonic Distortion	f = 20Hz to 20kHz, V_{COM} = 0.5 V_{P-P} , DC Bias = 0, R_L = 32Ω			0.01		%
$C_{NO_(Off)}$ $C_{NC_(Off)}$	NO_, NC_ Off- Capacitance	f = 1MHz, V _{COM} _ = 0.5V _{P-P} , DC Bias = 0			63		pF



Table 3. Electrical Characteristics (Continued)

Symbol	Parameter	Condition		Тур	Max	Unit		
C _{COM_(ON)}	COM On-Capacitance	$f = 1MHz$, $V_{COM} = 0.5V_{P-P}$, DC Bias = 0		196		pF		
Digital I/O	Digital I/O (IN_)							
Viii	VIH Input Logic High Voltage	Vcc = 2.7V to 3.6V	1.4			V		
VIH		Vcc = 4.2V to 5.5V	2.0					
VIL	Input Logic Low	Vcc = 2.7V to 3.6V			0.5	V		
VIL	Voltage	Vcc = 4.2V to 5.5V			0.8	V		
lin	Input Leakage Current	$VIN_= 0V$ to VCC , $VCC = 5.5V$	-1		+1	μΑ		
Power Supply								
Vcc	Power-Supply Range		1.8		5.5	V		
Icc	Supply Current	Vcc = 5.5V, VIN_ = 0V or Vcc		0.01	1	μΑ		

^{1.} Guaranteed by design



7 Typical Operating Characteristics

VCC = 3.0V, $T_A = +25^{\circ}C$ (unless otherwise specified).

Figure 3. ON-Resistance vs. Vcom

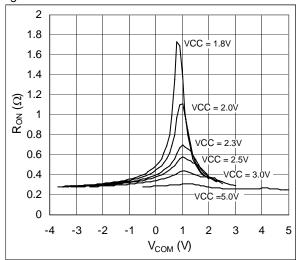


Figure 5. ON Resistance vs. Vcom; Vcc=5.0V

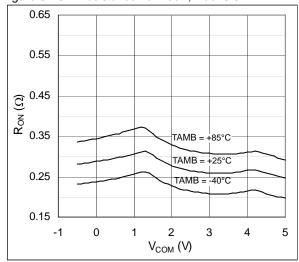


Figure 7. Frequency Response

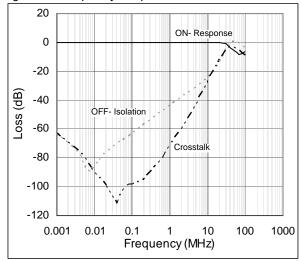


Figure 4. ON Resistance vs. Vcom; Vcc=3.0V

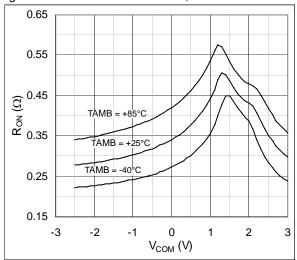


Figure 6. Charge Injection vs. VCOM; CLOAD = 1nF

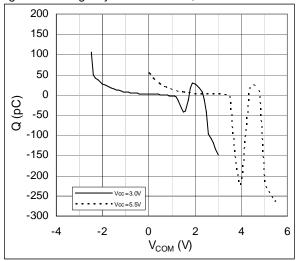


Figure 8. Logic Threshold Voltage vs. Vcc

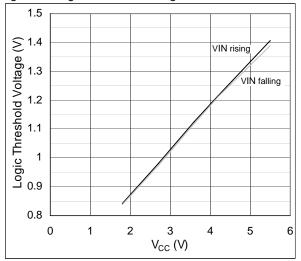




Figure 9. Turn-ON/OFF vs. Temperature; Vcc = 3V

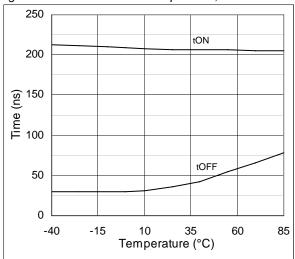


Figure 10. Turn-ON/OFF Times vs. Vcc

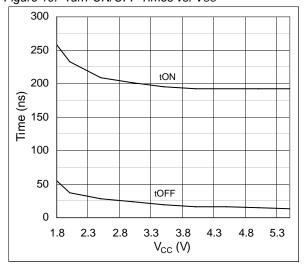


Figure 11. Leakage Current vs. Temperature

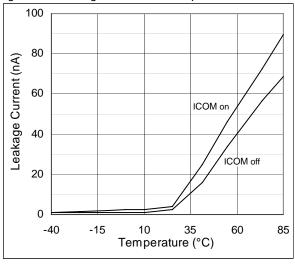


Figure 12. Icc vs. Vcc

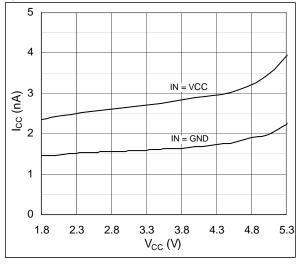


Figure 13. Total Harmonic Distortion vs. Frequency

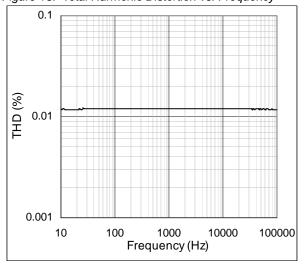
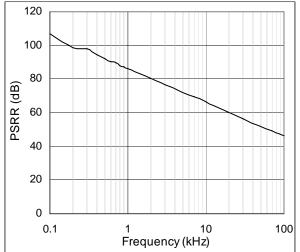


Figure 14. PSRR vs. Frequency





8 Detailed Description

The AS1747 operates from a +1.8V to +5.5V supply and features a negative signal capability that allows signals below ground to pass through without distortion. A break-before-make switching and a low on-resistance is also included in this analog dual SPDT switch. The device is fully specified for a 3.0V application.

9 Application Information

Digital Control Inputs

The logic inputs of the AS1747 accept up to +5.5V independent of the supply voltage. Due to this a mixing of the logic levels in a system is possible. For example, with a +3.3V supply, IN_ can be driven low to GND and high to +5.5V. For a +1.8V supply voltage, the logic levels are 0.5V (low) and 1.4V (high); for a +5V supply voltage, the logic levels are 0.8V (low) and 2.0V (high).

Analog Signal Levels

The change of the on-resistance of the AS1747 is very little for analog input signals over the whole supply voltage range. The switches are bi-directional, so the NO_, NC_, and COM_ pins can be either inputs or outputs.

The AS1747 pass signals as low as Vcc - 5.5V, including signals below ground with minimal distortion.

Power-Supply Sequencing and Overvoltage Protection

Caution: Do not exceed the absolute maximum ratings since stresses beyond the listed ratings may cause permanent damage to the device.

Proper power-supply sequencing is recommended for all CMOS devices. Always apply Vcc before applying analog signals, especially if the analog signal is not current-limited.



10 Timing Diagrams

Figure 15. Switching Time

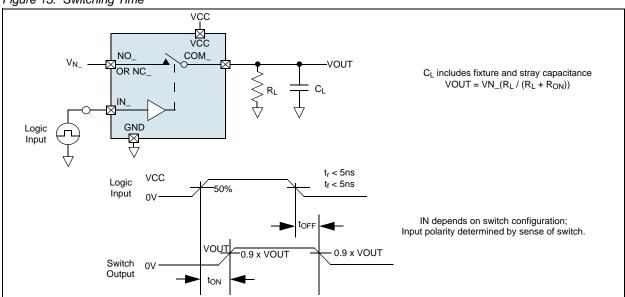


Figure 16. Break-Before-Make Interval

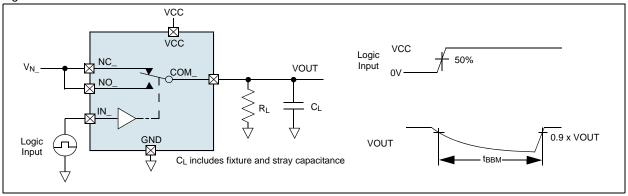


Figure 17. Charge Injection

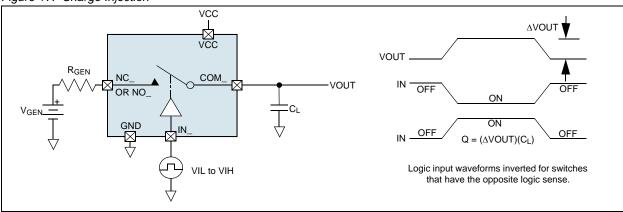
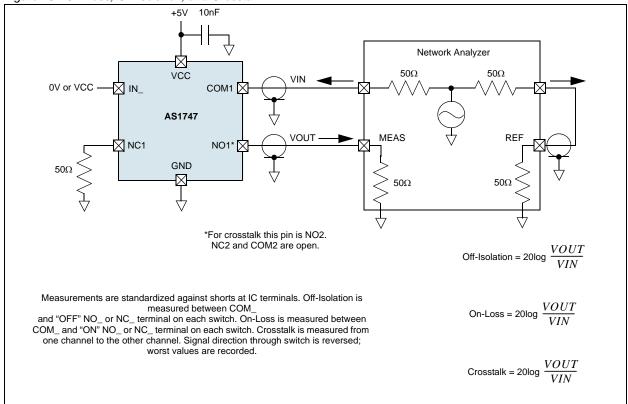




Figure 18. On-Loss, Off-Isolation, and Crosstalk

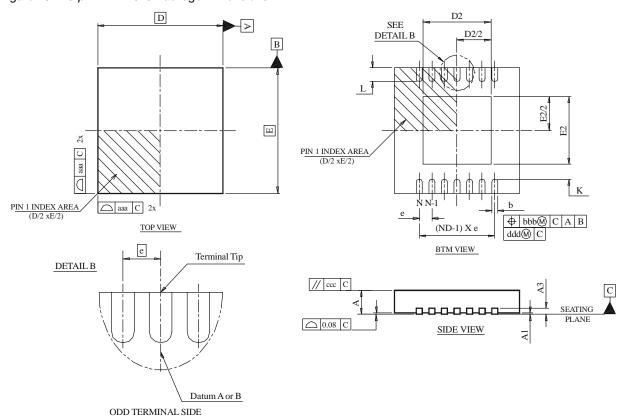




11 Package Drawings and Markings

The devices are available in 10-pin TDFN 3x3 package.

Figure 19. 10-pin TDFN 3x3 Package Dimensions



Symbol	Min	Nom	Max		
Α	0.70	0.75	0.80		
A1	0.00	0.02	0.05		
А3	0.20 REF				
θ	0° 14°				
aaa	0.15				
bbb	0.10				
CCC	0.10				
ddd	0.05				
eee	0.08				
999	0.10				

Symbol	Min	Nom	Max	
D BSC		3.00		
E BSC		3.00		
D2	2.20		2.70	
E2	1.40		1.75	
L	0.30	0.40	0.50	
K	0.20			
b	0.18	0.25	0.30	
е	0.50			
N		10		
ND		5		

Notes:

- 1. Figure 19 is shown for illustration only.
- 2. Dimensioning and tolerancing conform to ASME Y14.5M-1994.
- 3. All dimensions are in millimeters, angle is in degrees.
- 4. N is the total number of terminals.
- 5. ND refers to the maximum number of terminals on D side.



12 Ordering Information

The devices are available as the standard products shown in Table 4.

Table 4. Ordering Information

Model	Description	Delivery Form	Package
AS1747-BTDT	Dual 0.60hm SPDT, Audio Clickless Switch with	Tape & Reel	10-pin TDFN
701747-0101	Negative Rail Capability	Tape & Neel	(3.0mm x 3.0mm)

Note: All products are RoHS compliant and Pb-free.

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Contact Information

Headquarters

austriamicrosystems AG Tobelbaderstrasse 30 A-8141 Unterpremstaetten, Austria

Tel: +43 (0) 3136 500 0 Fax: +43 (0) 3136 525 01

For Sales Offices, Distributors and Representatives, please visit:

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